

HT9302 Series

1-Memory/2-Memory Tone/Pulse Dialer

Patent Number: 64097, 86474, 64529, 113235 (R.O.C.) 5424740 (U.S.A.)

Features

- · Universal specification
- Operating voltage: 2.0V~5.5V
- · Low standby current
- Low memory retention current: 0.1μA (typ.)
- Tone/pulse switchable
- Interface with LCD driver
- · 32 digits for redialing
- · 32 digits for SA memory dialing
- · One-key redialing
- Pause and P→T key for PBX
- 4×4 keyboard matrix
- 3.58MHz crystal or ceramic resonator

- Hand-free control
- · Hold-line control
- Pause, P→T can be saved for redialing
- Lock function
- Resistor options
 - M/B ratio
 - Flash function and flash time
 - Pause and P→T duration
 - Pulse number

 HT9302A: 18-pin DIP package HT9302B: 22-pin SKDIP package HT9302C: 20-pin DIP package HT9302D: 24-pin SKDIP package HT9302G: 16-pin DIP package

General Description

The HT9302 series tone/pulse dialers are CMOS LSIs for telecommunication systems. They are designed to meet various dialing specifications through resistor option matrix.

The HT9302 series provide the pin-selected lock func-

tion, Hold-line, Hand-free and LCD dialing number display interface, all of which are suitable for feature phone applications. HT9302G is simpler than HT9302X version. It provides only a redialing memory for simple low-cost system applications.

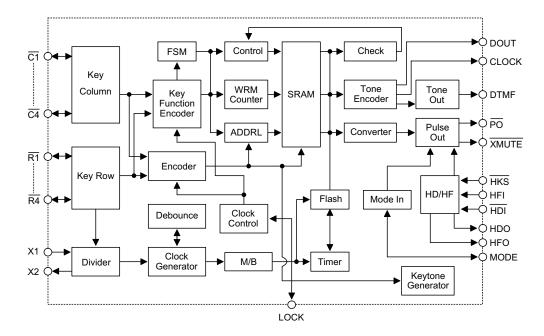
Selection Table

Function Part No.	Lock Function (Pin Selection)	Hold Line	Hand Free	LCD Interface	Package
HT9302x		((Normal version)		
HT9302A	\checkmark	_	_	_	18 DIP
HT9302B	V	√	V	_	22 SKDIP
HT9302C	V	_	_	√	20 DIP
HT9302D	√	√	√	√	24 SKDIP
HT9302G	(Simple version)				
HT9302G	_				16 DIP

Rev. 1.20 1 September 30, 2002

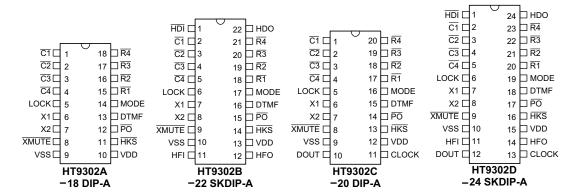


Block Diagram

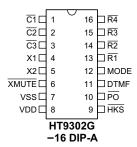


Pin Assignment

HT9302x normal version



HT9302G simple version

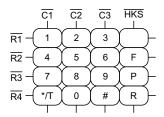




Keyboard Information

HT9302A/B/C/D

HT9302G



Pin Description

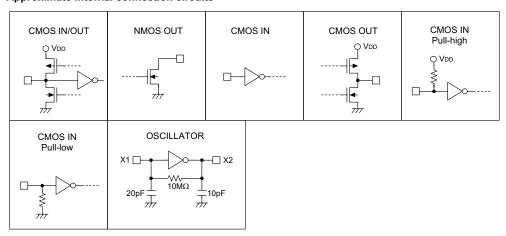
Pin Name	I/O	Internal Connection	Description	
<u>C1</u> ~ <u>C4</u> R1~R4	I/O	CMOS IN/OUT	These pins form a 4×4 keyboard matrix which can perform keyboard input detection and dialing specification setting functions. When on-hook ($\overline{\text{HKS}}$ =high) all the pins are set high. While off-hook the column group ($\overline{\text{C1}}$ ~ $\overline{\text{C4}}$) remains low and the row group ($\overline{\text{R1}}$ ~ $\overline{\text{R4}}$) is set high for key input detection. An inexpensive single contact 4×4 keyboard can be used as an input device. Pressing a key connects a single column to a single row, and actuates the system oscillator that results in a dialing signal output. If more than two keys are pressed at the same time, no response occurs. The key-in debounce time is 20ms. Refer to the keyboard information for keyboard arrangement and to the functional description for dialing specification selection.	
X1	ı		The system oscillator consists of an inverter, a bias resistor and the necessary	
X2	0	OSCILLATOR	load capacitor on chip. Connecting a standard 3.579545MHz crystal or cerar resonator to the X1 and X2 terminals can implement the oscillator function. To oscillator is turned off in the standby mode, and is actuated whenever a k board entry is detected.	
XMUTE	0	NMOS OUT	$\overline{\text{XMUTE}}$ is an NMOS open drain structure pulled to VSS during dialing signal transmission. Otherwise, it is an open circuit. The $\overline{\text{XMUTE}}$ is used to mute the speech circuit when transmitting the dial signal.	
HKS	I	CMOS IN	This pin is used to monitor the status of the hook-switch and its combination with HFI/HDI can control the PO pin output to make or break the line. HKS=VDD: On-hook state (PO=low). Except for HFI/HDI (hand-free/hold-line control input), other functions are all disabled. HKS=VSS: Off-hook state (PO=high). The chip is in the standby mode and ready to receive the key input.	
PO	0	CMOS OUT	This pin is a CMOS output structure, which by receiving HKS and HFO/HDO signals, control the dialer to connect or disconnect the telephone line. PO outputs a low to break the line when HKS is high (on-hook) and HFO/HDO is low. PO outputs a high to make the line when HKS is low (off-hook) or HFO is high or HDO is high. During the off-hook state, the pin also outputs the dialing pulse train in pulse mode dialing. While in the tone mode, this pin is always high.	
MODE	I/O	CMOS IN/OUT	This is a three-state input/output pin, used for dialing mode selection whether Tone mode or Pulse mode; 10pps/20pps. MODE=VDD: Pulse mode, 10pps MODE=OPEN: Pulse mode, 20pps MODE=VSS: Tone mode During pulse mode dialing, switching this pin to the tone mode changes the subsequent digit entry to tone mode. When the chips are in tone mode, switching to the pulse mode will also be recognized.	

Rev. 1.20 3 September 30, 2002



Pin Name	I/O	Internal Connection	Description
DTMF	0	CMOS OUT	This pin is active only when the chip transmits tone dialing signals. Otherwise, it always outputs a low. The pin outputs tone signals to drive the external transmitter amplifier circuit. The load resistor should not be less than $5k\Omega$.
HDI	I	CMOS IN Pull-high	This pin is a Schmitt trigger input structure. Active low. Applying a negative going pulse to this pin can toggle the HDO output once. An external RC network is recommended for input debouncing. The Pull-high resistance is $200k\Omega$ typ.
HDO	0	CMOS OUT	The HDO is a CMOS output structure. Its output is toggle- controlled by a negative transition on $\overline{\text{HDI}}$. When HDO is toggled high, PO keeps high to hold the line. The hold function can be released by setting HFO high or by an on-off hook operation or by another $\overline{\text{HDI}}$ input. Refer to the functional description for the hold-line function.
HFI	ı	CMOS IN Pull-low	This pin is a Schmitt trigger input structure. Active high. Applying a positive going pulse to HFI can toggle the HFO once and hence control the hand-free function. The Pull-low resistance of HFI is $200 \mathrm{k}\Omega$ typ. An external RC network is recommended for input debouncing.
HFO	0	CMOS OUT	The HFO is a CMOS output structure. Its output is toggle- controlled by a positive transition on HFI pin. When HFO is high, the hand-free function is enabled and \overline{PO} outputs a high to connect the line. The hand-free function can be released by setting HDO high or by an on-off-hook operation or by another HFI input. Refer to the functional description for the hand-free functional operation.
LOCK	I/O	CMOS IN/OUT	This is a three-state input/output pin, used for controlling long distance call function with a lock-switch. LOCK=OPEN: Normal dialing (no lock) LOCK=VDD: "0, 9" is inhibited for use as the first key input LOCK=VSS: "0" is inhibited for use as the first key input
DOUT	0	NMOS OUT	NMOS open drain output pin. It outputs the BCD code of the dialing digits to the LCD driver chip (HT16XX series) or MCU for dialing number display. Refer to the functional description for the detailed timing.
CLOCK	0	NMOS OUT	NMOS open drain output. When dialing, it outputs a series of pulse trains for DOUT data synchronization. DOUT data is valid at the falling edge of clock.
VDD	_	_	Positive power supply, 2.0V~5.5V for normal operation
VSS	_	_	Negative power supply, ground

Approximate internal connection circuits



Rev. 1.20 4 September 30, 2002



Absolute Maximum Ratings

Supply Voltage0.3V to 6V	Storage Temperature50°C to 125°C
Input VoltageV _{SS} -0.3 to V _{DD} +0.3V	Operating Temperature20°C to 75°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Electrical Characteristics

 f_{OSC} =3.5795MHz, Ta=25°C

Cumbal	Pororector	Test Conditions			M:	T		Unit
Symbol	Parameter	V_{DD}	С	onditions	Min.	Тур.	Max.	Unit
V_{DD}	Operating Voltage	_		_	2	_	5.5	V
			Pulse	Off-hook	_	0.2	1	mA
I _{DD}	Operating Current	2.5V	Tone	Keypad entry No load	_	0.6	2	mA
I _{STB}	Standby Current	1V	On-hoo	ok, no load Ty	_	_	1	μА
V_{R}	Memory Retention Voltage	_		_	1	_	5.5	V
I_R	Memory Retention Current	1V	On-hoo	ok	_	0.1	0.2	μΑ
V_{IL}	Input Low Voltage	_		_	V _{SS}	_	0.2V _{DD}	V
V_{IH}	Input High Voltage	_		_	0.8V _{DD}	_	V_{DD}	V
I _{XMO}	XMUTE Leakage Current	_	V _{XMUTE} =12V No entry		_	_	1	μА
I_{OLXM}	XMUTE Sink Current	2.5V	V _{XMUTE} =0.5V		1	_	_	mA
I _{HKS}	HKS Pin Input Current	2.5V	V _{HKS} =2.5V		_	_	0.1	μΑ
R _{HFI}	HFI Pull-low Resistance	2.5V	V _{HFI} =2.5V		_	200	_	kΩ
$R_{\overline{HDI}}$	HDI Pull-high Resistance	2.5V	V _{HDI} =0	V	_	200	_	kΩ
I _{OH1}	Keypad Pin Source Current	2.5V	V _{OH} =0'	V	-4	_	40	μΑ
I _{OL1}	Keypad Pin Sink Current	2.5V	V _{OL} =2.	5V	200	400	_	μΑ
I _{OH2}	HFO Pin Source Current	2.5V	V _{OH} =2	V	-1	_	_	mA
I _{OL2}	HFO Pin Sink Current	2.5V	V _{OL} =0.	5V	1	_	_	mA
I _{OH3}	HDO Pin Source Current	2.5V	V _{OH} =2	V	-1	_	_	mA
I_{OL3}	HDO Pin Sink Current	2.5V	V _{OL} =0.	5V	1	_	_	mA
t	Pause Time After Flash		Contro	key	_	0.2	_	
t _{FP}	Pause Time Aller Flash		Digit key		_	1	_	S
t _{RP}	One-key Redialing Pause Time	_	One-key redialing		_	1	_	s
t _{DB}	Key-in Debounce Time	_		_	_	20	_	ms
t _{BRK}	Break Time for One-key Redialing	_	One-ke	y redialing	_	1.2		s
fosc	System Frequency	_	Crystal	=3.5795MHz	3.5759	3.5795	3.5831	MHz

Rev. 1.20 5 September 30, 2002



Pulse Mode Electrical Characteristics

 f_{OSC} =3.5795MHz, Ta=25°C

Cumb al	Davameter	Test Conditions		Min.	Tim	Max.	Unit		
Symbol	Parameter	V _{DD}	Conditions	IVIIII.	Тур.	IVIAX.	Ullit		
I_{POH}	PO Output Source Current	2.5V	V _{OH} =2V	-0.2	_		mA		
I _{POL}	PO Output Sink Current	2.5V	V _{OL} =0.5V	0.2	0.6	_	mA		
DD	Pulse Rate		MODE pin is connected to V _{DD}	_	10	_			
PR	Pulse Rate	_	MODE pin is opened	_	20	_	pps		
M/B	Malia (Danala Datia		A resistor is linked between $\overline{R2}$ and $\overline{C1}$	_	33:66	_	%		
IVI/B	Make/Break Ratio		$\frac{\text{No resistor}}{\text{R2}}$ and $\frac{\text{C1}}{\text{C1}}$	_	40:60	_	%		
					M/B ratio=40:60	_	40 (10pps) 20 (20pps)	_	
t _{PDP}	Pre-digit-pause Time		M/B ratio=33:66	_	33 (10pps) 17 (20pps)	_	ms		
	later dicit serves Times		Pulse rate=10pps	_	800	_			
t _{IDP}	Inter-digit-pause Time	_	Pulse rate=20pps	_	500	_	ms		
4	Pulse Make Duration		A resistor is linked between $\overline{R2}$ and $\overline{C1}$	_	33 (10pps) 17 (20pps)				
t _M	Pulse Make Duration		$\frac{\text{No resistor}}{\text{R2}}$ and $\frac{\text{C1}}{\text{C1}}$	_	40 (10pps) 20 (20pps)	_	ms		
+_	Dulas Brack Duration		A resistor is linked between $\overline{R2}$ and $\overline{C1}$	_	66 (10pps) 33 (20pps)				
t _B	Pulse Break Duration		$\frac{\text{No resistor}}{\text{R2}}$ and $\frac{\text{C1}}{\text{C1}}$	_	60 (10pps) 30 (20pps)		ms		

Tone Mode Electrical Characteristics

 f_{OSC} =3.5795MHz, Ta=25°C

Cumbal	Parameter	Test Conditions		Min.	Time	Max.	Unit	
Symbol	Parameter	V_{DD}	Conditions	i	IVIIII.	Тур.	wax.	Ullit
V _{TDC}	DTMF Output DC Level	_			0.45V _{DD}		0.7V _{DD}	V
I _{TOL}	DTMF Sink Current	2.5V	V _{DTMF} =0.5V		0.1		_	mA
V _{TAC}	DTMF Output AC Level	_	- Row group, R _L =5kΩ		0.12	0.155	0.18	Vrms
R _L	DTMF Output Load	2.5V	5V THD≤–23dB		5		_	kΩ
A _{CR}	Column Pre-emphasis	2.5V	Row group=0dB		1	2	3	dB
THD	Tone Signal Distortion	2.5V	$R_L=5k\Omega$		_	-30	-23	dB
4	Minimum Town Dunation		Auto modial	Others		82.5	_	
t _{TMIN}	Minimum Tone Duration	_	Auto-redial 9302G			100	_	ms
4	Minimum Interntone Deven		Others		_	85.5	_	
t _{ITPM}	Minimum Inter-tone Pause A	— Auto-redial 93020		_	106	_	ms	

THD (Distortion) (dB) = 20 log (
$$\sqrt{V1^2 + V2^2 + ... Vn^2} / \sqrt{Vi^2 + Vh^2}$$
)

Vi, Vh: Row group and column group signals

V1, V2, ... Vn: Harmonic signals (BW=300Hz~3500Hz)



Functional Description

Keyboard matrix

 $\overline{\text{C1}}{\sim}\overline{\text{C4}}$ and $\overline{\text{R1}}{\sim}\overline{\text{R4}}$ form a keyboard matrix. Together with a standard 4×4 keyboard, the keyboard matrix is used for dialing entries. In addition, the keyboard matrix provides resistor option for different dialing specification selections. The keyboard arrangement for each of the HT9302 series are shown in the **Keyboard Information**.

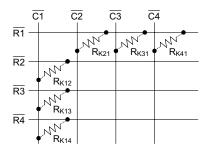
Tone frequency

Tone	Output Fre	% Error	
Name	Specified	Actual	% EIIOI
R1	697	699	+0.29%
R2	770	766	-0.52%
R3	852	847	-0.59%
R4	941	948	+0.74%
C1	1209	1215	+0.50%
C2	1336	1332	-0.30%
C3	1477	1472	-0.34%

Note: % Error does not contain the crystal frequency drift

Dialing specification selection

By means of adding resistors on the keyboard matrix pins, various dialing specifications can be selected. The allowable option resistor connections are shown.



All the resistors are $330k\Omega$. The resistor option functions and the default specifications (without option resistors) are listed below.

Option Resistor	Option Function	Default (No Resistor)
R _{K12}	Make/Break Ratio Selection	40:60
R _{K13}	Flash Function and	Flash=control function
R _{K14}	Flash Time Selection	Flash time=600ms
R _{K21}	Pause & P→T Duration Selection	t_P =3.6s $t_{P \to T}$ =3.6s
R _{K31}	Pulse Number	N
R _{K41}	Selection	IN

M/B ratio selection table

R _{K12}	M/B Ratio (%)		
No	40:60		
Yes	33.3:66.6		

Flash function/time (duration) selection table

	, ,				
R _{K13}	R _{K14}	Flash Function	Flash Time (t _F)		
No	No	Control	600ms		
No	Yes	Digit	600ms		
Yes	No	Digit	98ms		
Yes	Yes	Digit	300ms		

Pause and P→T duration selection table

R _{K21}	t _P (sec)	t _{P→T} (sec)
No	3.6	3.6
Yes	2	1

Pulse number selection table

• This table shows pulse number selections for HT9302x.

R _{K31}	R _{K41}	Pulse Number
No	No	N
No	Yes	N+1
Yes	No	10-N
Yes	Yes	_

• HT9302G has different selection method listed in the table below.

R _{K31}	Pulse Number	
No	N	
Yes	10-N	



Pulse number table

Keypad	Outp	ut Pulse Nเ	ımber	
Digit Key	Normal N	New Zealand (10-N)	Sweden/ Denmark (N+1)	
1	1	9	2	
2	2	8	3	
3	3	7	4	
4	4	6	5	
5	5	5	6	
6	6	4	7	
7	7	3	8	
8	8	2	9	
9	9	1	10	
0	10	10	1	
*/T	P→T	P→T	P→T	
#	Ignored	Ignored	Ignored	

Hand-free function operation

- Hand-free function execution
 When HFO is low, a rising edge triggers the HFI, enabling the Hand-free function (HFO becomes high).
- Reset Hand-free function
 When HFO is high, the Hand-free function is enabled and can be reset by:
 - Off-hook
 - Applying a rising edge to HFI
 - Changing the HDO pin from low to high
- Hand-free function table

Cur	rent St	tate	Input		Next State		
HKS	HFO	HDO	HDI	HFI	HKS	HFO	HDO
Н	L	Х	Н	L	An	L	An
Н	L	Х	Н	₫	An	Н	L
Н	Н	Х	Н	Ī	An	L	An
Н	Х	L	Н	L	L	L	L
L	L	Х	Н	L	An	L	An
L	L	Х	Н	₫	An	Н	L
L	Н	L	Н	Ī	An	L	An
L	Х	Х	Н	L	Н	An	An
Х	Х	L	¥	L	An	L	Н

H: Logic HIGH L: Logic LOW X: Don't care An: Unchanged

Hold-line function operation

- Hold-line function execution
 When HDO is low, a falling edge triggers the HDI, enabling the Hold-line function (HDO becomes high).
 The XMUTE remains low when HDO is high.
- Reset Hold-line function
 When HDO is high, the Hold-line function is enabled
 and can be reset by:
 - Off-hook
 - Applying a falling edge to HDI
 - Changing the HFO pin from low to high
- Hold-line function table

Cur	rent State		Input			Next	State
HKS	HDO	HFO	HFI	HDI	HKS	HDO	HFO
Н	L	Х	L	Н	An	L	An
Н	L	Х	L	¥	An	Н	L
Н	Н	L	L	¥	An	L	An
Н	Х	Х	L	Н	L	L	L
L	L	Х	L	Н	An	L	An
L	L	Х	L	Ŧ	An	Н	L
L	Н	L	L	₹	An	L	An
L	х	Х	L	Н	Н	An	An
Х	Х	L	<u></u>	Н	An	L	Н

H: Logic HIGH L: Logic LOW X: Don't care An: Unchanged ☐: Rising edge ☐: Falling edge

DOUT BCD code

When dialing, the corresponding 4-bit BCD codes are serially presented on DOUT from MSB to LSB. The data of DOUT is valid at the falling edge of the CLOCK pin. The following table lists the BCD codes corresponding to the keyboard input.

Key-In	BCD Code	Key-In	BCD Code
1	0001	8	1000
2	0010	9	1001
3	0011	0	1010
4	0100	*/T	1101
5	0101	#	1100
6	0110	F	1011
7	0111	Р	1110



LOCK function

The function aims to detect locked dialing number to prevent a long distance call. The dialing output of the chip is disabled if the first input key after on-off-hook is the locked number when the lock function is enabled. The lock function selection is listed below.

• HT9302x version

LOCK Pin	Function	
OPEN	Normal dialing (no lock)	
VDD	"0, 9" is inhibited	
VSS	"0" is inhibited	

Key definition

• 0,1,2,3,4,5,6,7,8,9 keys

These are dialing number input keys for both the pulse mode and the tone mode operations.

*/T

This key executes the $P \rightarrow T$ function and waits a $t_{P \rightarrow T}$ duration in the pulse mode. On the other hand, the */T key executes the * function in the tone mode.

• #

This is a dialing signal key for the tone mode only, no response in the pulse mode.

SA

Pressing this key can save the preceding dialing telephone numbers. The saved number is redialed if it is pressed again. SA will also redial the saved number if it is the first key pressed at the off-hook state. During the dialing signal transmission, the SA key is inhibited.

• F

The flash key can be selected as a digit or a control key by the option resistors R_{K13} & R_{K14} . Pressing the flash key will force the \overline{PO} pin to be "low" for the t_F duration and is then followed by t_{FP} (sec). t_F can also be selected by t_{K13} , t_{K14} .

• P

Pause key. The execution of the pause key pauses the output for the t_{P} duration. t_{P} can be selected by $R_{\text{K21}}.$

R

Redial key. Executes redialing as well as one-key redial function.

• ST

This key can store lock number with personal code in IDD lock operation.

• R/P

Redial and pause function key. If it is pressed as the first key after off-hook, this key executes the redial function. Otherwise, it works as the pause key.

Rev. 1.20 9 September 30, 2002



Keyboard operation

The following operations are described under an on-off- hook or on-hook condition with the hand-free active condition.

Normal dialing

- Pulse mode Tone mode (a) without */T (a) without */T Keyboard input: D1 D2 ... Dn Keyboard input: D1 D2 ... Dn Dialing output: D1 D2 ... Dn Dialing output: D1 D2 ... Dn RM: D1 D2 ... Dn RM: D1 D2 ... Dn SAM: Unchanged SAM: Unchanged (b) with */T (b) with */T Keyboard input: D1 D2 ... Dn */T Dn+1 ... Keyboard input: D1 D2 ... Dn */T Dn+1 ... Dm Dm Dialing output: D1 D2 ... Dn $t_{P \rightarrow T}$ Dn+1 ... Dm Dialing output: D1 D2 ... Dn * Dn+1 ... Dm Pulse Tone RM: D1 D2 ... Dn * Dn+1 ... Dm RM: D1 D2 ... Dn */T Dn+1 ... Dm SAM: Unchanged SAM: Unchanged

Note: The maximum capacity of the RM memory is 32 digits. When more than 32 digits are entered, the signal is transmitted but the redial function is inhibited.

Redial

- Pulse mode

(a) without */T

RM content: D1 D2 ... Dn

Keyboard input: [R or R/P]

Dialing output: D1 D2 ... Dn

RM: Unchanged SAM: Unchanged

(b) with */T

RM content: D1 D2 ... Dn */T Dn+1 ... Dm

Keyboard input: [R or R/P]

Dialing output: $\underbrace{D1\ D2\dots Dn}_{Pulse}\ t_{P\to T}\ D\underline{n+1\dots Dm}_{Tone}$

RM: Unchanged SAM: Unchanged

Tone mode

(a) without */T

RM content: D1 D2 ... Dn

Keyboard input: [R or R/P]

Dialing output: D1 D2 ... Dn

RM: Unchanged SAM: Unchanged

(b) with */T

RM content: D1 D2 ... Dn */T Dn+1 ... Dm

Keyboard input: [R or R/P]

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm

RM: Unchanged SAM: Unchanged



· One-key redial

```
- Pulse mode
                                                     Tone mode
  (a) without */T
                                                      (a) without */T
     Keyboard input: D1 D2 ... Dn R
                                                         Keyboard input: D1 D2 ... Dn R
     Dialing output: D1 D2 ... Dn tBRK tRP
                                                         Dialing output: D1 D2 ... Dn tBRK tRP D1 D2
                   D1 D2 ... Dn
                                                                       ... Dn
     RM: D1 D2 ... Dn
                                                         RM: D1 D2 ... Dn
     SAM: Unchanged
                                                         SAM: Unchanged
  (b) with */T
                                                      (b) with */T
     Keyboard input: D1 D2 ... Dn */T Dn+1 ...
                                                         Keyboard input: D1 D2 ... Dn */T Dn+1 ...
                    Dm R
                                                                        Dm R
                                                         Dialing output: D1 D2 ... Dn * Dn+1 ... Dm
     Dialing output: D1 D2 ... Dn tP→T Dn+1 ... Dm
                       Pulse
                                         Tone
                                                                       tBRK tRP D1 D2 ... Dn * Dn+1
                   tbrk trp D1 D2 ... Dn tp→T
                                                                        ... Dm
                               Pulse
                                                         RM: D1 D2 ... Dn * Dn+1 ... Dm
                   Dņ+1 ... Dm
                                                         SAM: Unchanged
                       Tone
     RM: D1 D2 ... Dn */T Dn+1 ... Dm
     SAM: Unchanged
```

Note: If the dialing number exceeds 32 digits, redialing is inhibited and PO=VDD

SA copy

```
- Pulse mode
                                                      Tone mode
  (a) without */T
                                                      (a) without */T
     Keyboard input: D1 D2 ... Dn SA
                                                         Keyboard input: D1 D2 ... Dn SA
     Dialing output: D1 D2 ... Dn
                                                         Dialing output: D1 D2 ... Dn
     RM: D1 D2 ... Dn
                                                         RM: D1 D2 ... Dn
     SAM: D1 D2 ... Dn
                                                         SAM: D1 D2 ... Dn
  (b) with */T
                                                      (b) with */T
     Keyboard input: D1 D2 ... Dn */T Dn+1 ...
                                                         Keyboard input: D1 D2 ... Dn */T Dn+1 ...
                    Dm SA
                                                                        Dm SA
                                                          Dialing output: D1 D2 ... Dn * Dn+1 ... Dm
     Dialing output: D1 D2 ... Dn tP→T Dn+1 ... Dm
                       Pulse
                                          Tone
                                                          RM: D1 D2 ... Dn * Dn+1 ... Dm
     RM: D1 D2 ... Dn */T Dn+1 ... Dm
                                                          SAM: D1 D2 ... Dn * Dn+1 ... Dm
     SAM: D1 D2 ... Dn */T Dn+1 ... Dm
```

Note: The maximum capacity of the RM memory is 32 digits. When more than 32 digits plus the "SA" key are entered, the SAVE function will not be executed, and all the existing data in the save memory will not be changed.

Rev. 1.20 11 September 30, 2002



SA dialing

Pulse mode

(a) without */T

SAM content: D1 D2 ... Dn

Keyboard input: SA

Dialing output: D1 D2 ... Dn

RM: Unchanged SAM: Unchanged

(b) with */T

SAM content: D1 D2 ... Dn */T Dn+1 ... Dm

Keyboard input: SA

Dialing output: $\underbrace{D1\ D2\ ...\ Dn}_{Pulse}\ t_{P\rightarrow T}\ Dn+1\ ...\ Dm}_{Tone}$

RM: Unchanged SAM: Unchanged

Flash

- Flash as a digital key

(a) The intervenient key

Keyboard input: $\boxed{\text{D1}}$ $\boxed{\text{D2}}$... $\boxed{\text{Dn}}$ $\boxed{\text{F}}$ $\boxed{\text{Dn+1}}$... $\boxed{\text{Dm}}$

Dialing output: D1 D2 ... Dn tF tFP Dn+1 ... Dm

RM: D1 D2 ... Dn SAM: Unchanged

(b) The first key

Keyboard input: F D1 D2 ... Dn Dialing output: tr trp D1 D2 ... Dn

RM: Unchanged SAM: Unchanged

Pause

Keyboard input: D1 D2 ... Dn P Dn+1 ... Dm Dialing output: D1 D2 ... Dn tp Dn+1 ... Dm

RM: D1 D2 ... Dn P Dn+1 ... Dm

SAM: Unchanged

Note

RM: Redial memory SAM: Save dialing memory D1 D2 ... Dn: 0~9 Dn+1 ... Dm: 0~9, *, # Tone mode

(a) without */T

SAM content: D1 D2 ... Dn Keyboard input: SA

Dialing output: D1 D2 ... Dn

RM: Unchanged SAM: Unchanged

(b) with */T

SAM content: D1 D2 ... Dn * Dn+1 ... Dm

Keyboard input: SA

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm

RM: Unchanged SAM: Unchanged

Flash as a control key

Keyboard input: D1 D2 ... Dn F Dn+1 ...
Dm

Dialing output: D1 D2 ... Dn TF TFP Dn+1 ...

Dm RM: Dn+1 ... Dm

SAM: Unchanged

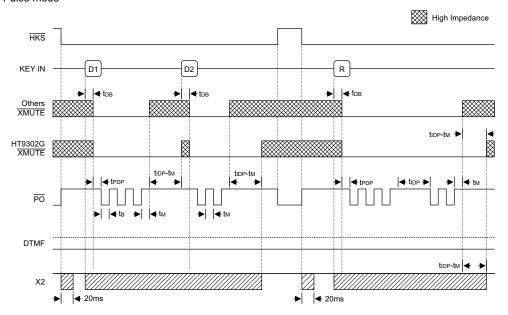
Note: Tr: break a flash time



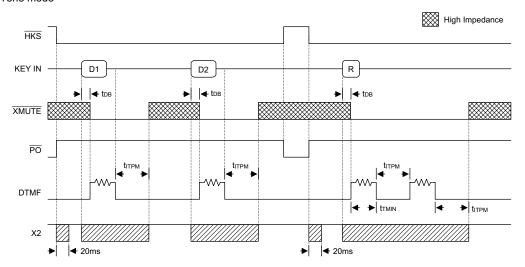
Timing Diagrams

Normal dialing

• Pulse mode



• Tone mode

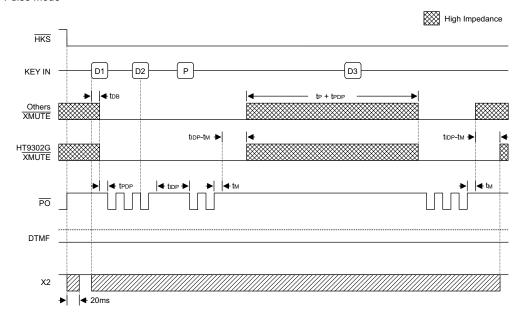


Rev. 1.20 13 September 30, 2002

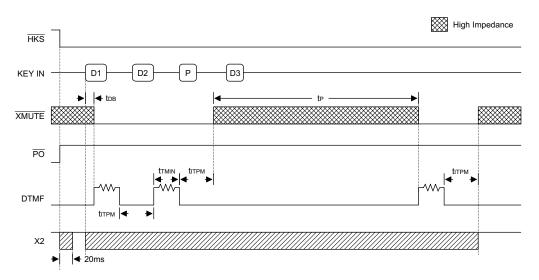


Dialing with pause key

• Pulse mode

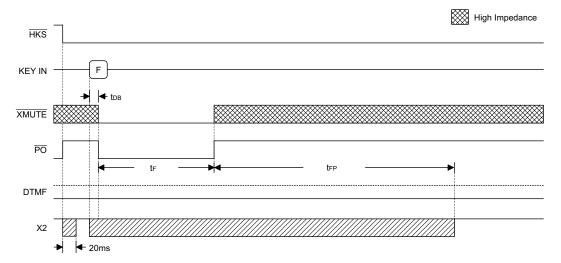


• Tone mode

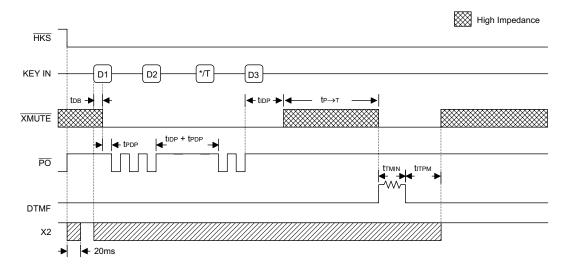




Flash key operation



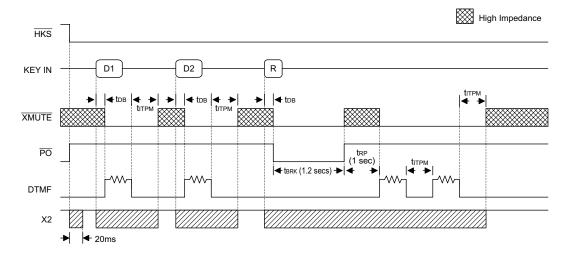
$\textbf{Pulse} {\rightarrow} \textbf{Tone operation}$



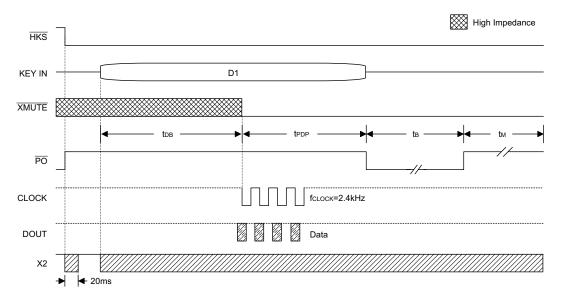
Rev. 1.20 15 September 30, 2002



One key redial operation

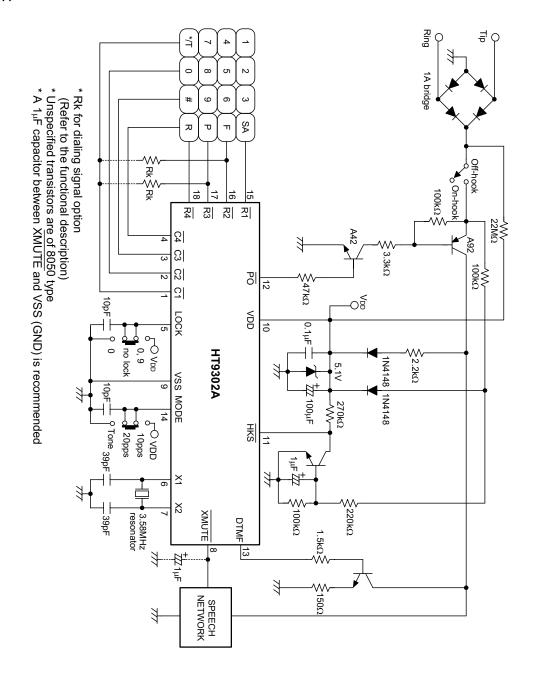


CLOCK & DOUT operation

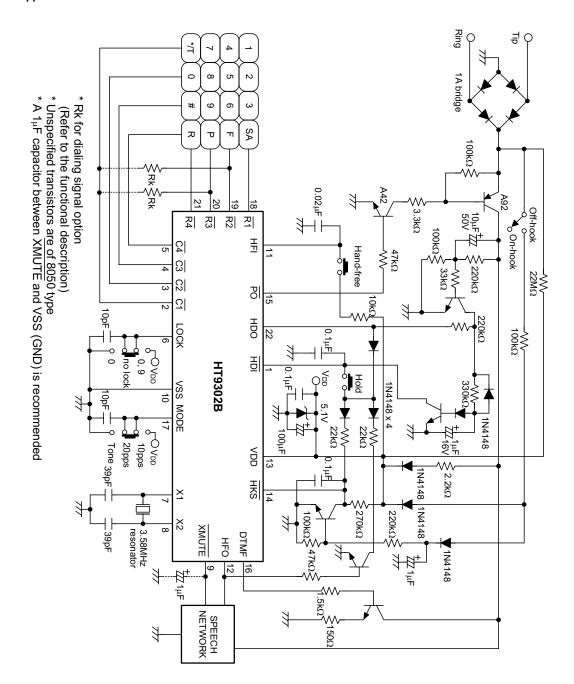


Note: D1=D3=3 D2=2

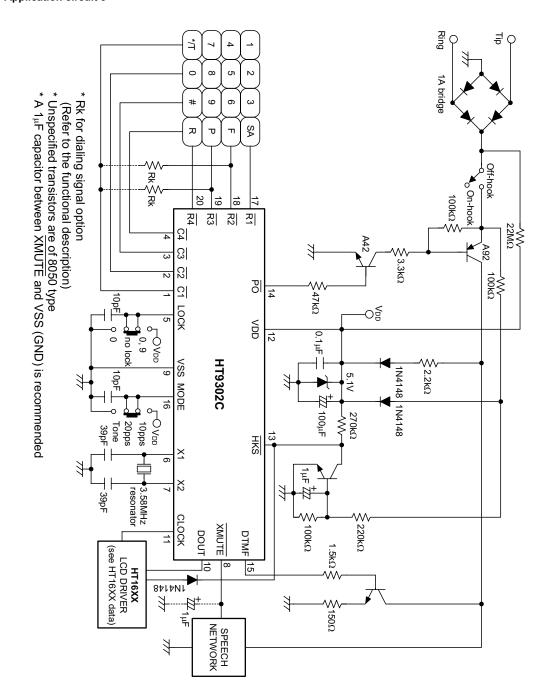




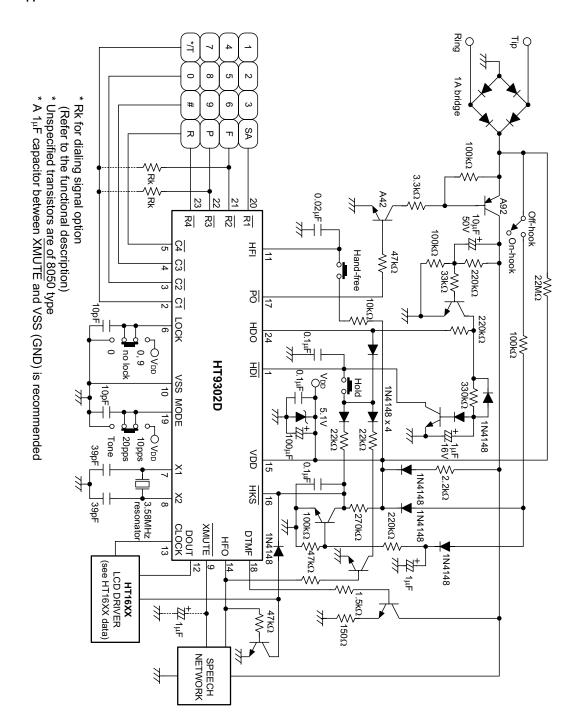




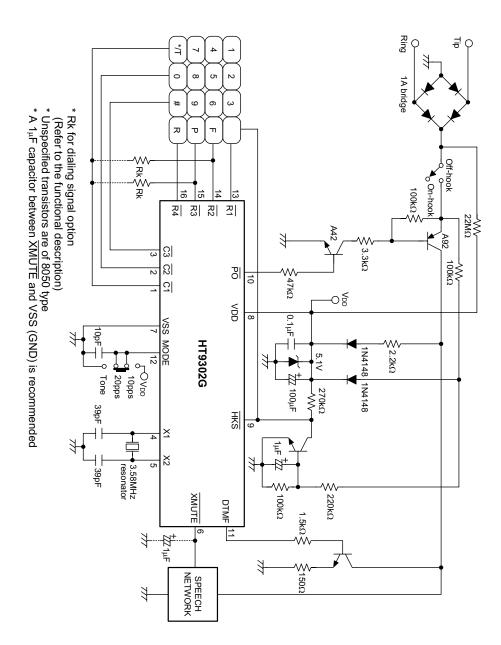








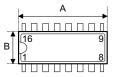


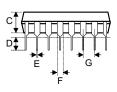




Package Information

16-pin DIP (300mil) outline dimensions



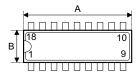


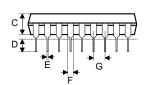


Comple at		Dimensions in mil			
Symbol	Min.	Nom.	Max.		
Α	745	_	775		
В	240	_	260		
С	125	_	135		
D	125	_	145		
E	16	_	20		
F	50	_	70		
G	_	100	_		
Н	295	_	315		
I	335	_	375		
α	0°	_	15°		



18-pin DIP (300mil) outline dimensions



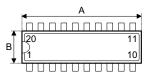


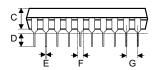


Symbol		Dimensions in mil			
Symbol	Min.	Nom.	Max.		
Α	895	_	915		
В	240	_	260		
С	125	_	135		
D	125	_	145		
E	16	_	20		
F	50	_	70		
G	_	100	_		
Н	295	_	315		
I	335	_	375		
α	0°	_	15°		



20-pin DIP (300mil) outline dimensions



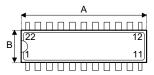


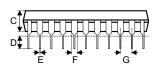


Comphal	Dimensions in mil			
Symbol	Min.	Nom.	Max.	
Α	1020	_	1045	
В	240	_	260	
С	125	_	135	
D	125	_	145	
E	16	_	20	
F	50	_	70	
G	_	100	_	
Н	295	_	315	
ļ	335	_	375	
α	0°	_	15°	



22-pin SKDIP (300mil) outline dimensions



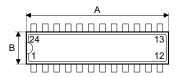


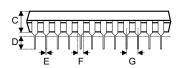


Symbol	Dimensions in mil			
Symbol	Min.	Nom.	Max.	
Α	1085	_	1105	
В	253	_	263	
С	125	_	135	
D	125	_	145	
Е	16	_	20	
F	50	_	70	
G	_	100	_	
Н	295	_	315	
1	330	_	375	
α	0°	_	15°	



24-pin SKDIP (300mil) outline dimensions







Comphal		Dimensions in mil			
Symbol	Min.	Nom.	Max.		
Α	1235	_	1265		
В	255	_	265		
С	125	_	135		
D	125	_	145		
E	16	_	20		
F	50	_	70		
G	_	100	_		
Н	295	_	315		
I	345	_	360		
α	0°	_	15°		



Holtek Semiconductor Inc. (Headquarters)

No.3, Creation Rd. II, Science-based Industrial Park, Hsinchu, Taiwan

Tel: 886-3-563-1999 Fax: 886-3-563-1189 http://www.holtek.com.tw

Holtek Semiconductor Inc. (Sales Office)

11F, No.576, Sec.7 Chung Hsiao E. Rd., Taipei, Taiwan

Tel: 886-2-2782-9635 Fax: 886-2-2782-9636

Fax: 886-2-2782-7128 (International sales hotline)

Holtek Semiconductor (Shanghai) Inc.

7th Floor, Building 2, No.889, Yi Shan Rd., Shanghai, China

Tel: 021-6485-5560 Fax: 021-6485-0313 http://www.holtek.com.cn

Holtek Semiconductor (Hong Kong) Ltd.

Block A, 3/F, Tin On Industrial Building, 777-779 Cheung Sha Wan Rd., Kowloon, Hong Kong Tel: 852-2-745-8288

Tel: 852-2-745-8288 Fax: 852-2-742-8657

Holmate Semiconductor, Inc.

46712 Fremont Blvd., Fremont, CA 94538

Tel: 510-252-9880 Fax: 510-252-9885 http://www.holmate.com

Copyright © 2002 by HOLTEK SEMICONDUCTOR INC.

The information appearing in this Data Sheet is believed to be accurate at the time of publication. However, Holtek assumes no responsibility arising from the use of the specifications described. The applications mentioned herein are used solely for the purpose of illustration and Holtek makes no warranty or representation that such applications will be suitable without further modification, nor recommends the use of its products for application that may present a risk to human life due to malfunction or otherwise. Holtek's products are not authorized for use as critical components in life support devices or systems. Holtek reserves the right to alter its products without prior notification. For the most up-to-date information, please visit our web site at http://www.holtek.com.tw.

Rev. 1.20 27 September 30, 2002